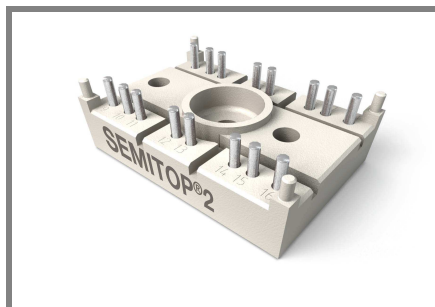


SK75GAR12T4



SEMITOP[®] 2

IGBT Module

SK75GAL12T4

SK75GAR12T4

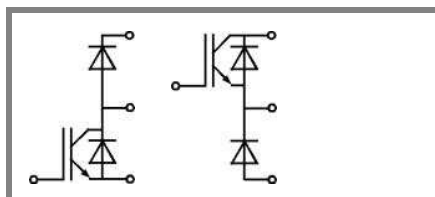
Features

- One screw mounting module
- Trench4 IGBT technology
- CAL4 technology FWD

Typical Applications*

Remarks

- $V_{CE,sat}$, V_F = chip level value



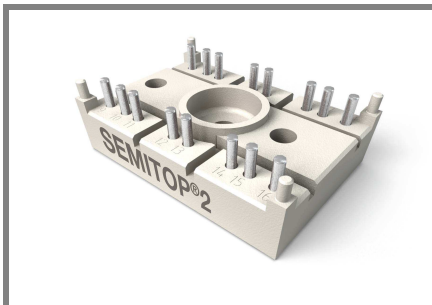
GAL

GAR

Absolute Maximum Ratings		$T_s = 25\text{ °C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT			
V_{CES}	$T_j = 25\text{ °C}$	1200	V
I_C	$T_j = 175\text{ °C}$	$T_s = 25\text{ °C}$	80
		$T_s = 70\text{ °C}$	65
I_{CRM}	$I_{CRM} = 3 \times I_{Cnom}$	225	A
V_{GES}		± 20	V
t_{psc}	$V_{CC} = 800\text{ V}$; $V_{GE} \leq 15\text{ V}$; $T_j = 150\text{ °C}$ $V_{CES} < 1200\text{ V}$	10	μs
Inverse Diode			
I_F	$T_j = 175\text{ °C}$	$T_s = 25\text{ °C}$	20
		$T_s = 70\text{ °C}$	16
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$	45	A
I_{FSM}	$t_p = 10\text{ ms}$; half sine wave $T_j = 150\text{ °C}$	90	A
Freewheeling Diode			
I_F	$T_j = 175\text{ °C}$	$T_s = 25\text{ °C}$	70
		$T_s = 70\text{ °C}$	55
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$	225	A
I_{FSM}	$t_p = 10\text{ ms}$; half sine wave $T_j = 150\text{ °C}$	425	A
Module			
$I_{t(RMS)}$			A
T_{vj}		-40 ... +175	$^{\circ}\text{C}$
T_{stg}		-40 ... +125	$^{\circ}\text{C}$
V_{isol}	AC, 1 min.	2500	V

Characteristics		$T_s = 25\text{ °C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 3\text{ mA}$	5	5,8	6,5	V
I_{CES}	$V_{GE} = 0\text{ V}$, $V_{CE} = V_{CES}$	$T_j = 25\text{ °C}$		1,0	mA
		$T_j = 150\text{ °C}$			mA
I_{GES}	$V_{CE} = 0\text{ V}$, $V_{GE} = 20\text{ V}$	$T_j = 25\text{ °C}$		600	nA
		$T_j = 150\text{ °C}$			nA
V_{CE0}		$T_j = 25\text{ °C}$	1,1	1,3	V
		$T_j = 150\text{ °C}$	1	1,2	V
r_{CE}	$V_{GE} = 15\text{ V}$	$T_j = 25\text{ °C}$	10		$\text{m}\Omega$
		$T_j = 150\text{ °C}$	16		$\text{m}\Omega$
$V_{CE(sat)}$	$I_{Cnom} = 75\text{ A}$, $V_{GE} = 15\text{ V}$	$T_j = 25\text{ °C}_{chiplev.}$	1,85	2,05	V
		$T_j = 150\text{ °C}_{chiplev.}$	2,25	2,45	V
C_{ies}	$V_{CE} = 25$, $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	4,4		nF
C_{oes}			0,29		nF
C_{res}			0,235		nF
Q_G	$V_{GE} = -7\text{ V} \dots +15\text{ V}$		570		nC
R_{Gint}	$T_j = 25\text{ °C}$		10		Ω
$t_{d(on)}$	$R_{Gon} = 15\text{ }\Omega$ $di/dt = 2000\text{ A}/\mu\text{s}$	$V_{CC} = 600\text{ V}$ $I_C = 75\text{ A}$	50		ns
t_r			60		ns
E_{on}			13		mJ
$t_{d(off)}$	$R_{Goff} = 15\text{ }\Omega$	$T_j = 150\text{ °C}$ $V_{GE} = -7/+15\text{ V}$	500		ns
t_f			60		ns
E_{off}			7		mJ
$R_{th(j-s)}$	per IGBT		0,74		K/W

SK75GAL12T4



SEMITOP® 2

IGBT Module

SK75GAL12T4

SK75GAR12T4

Features

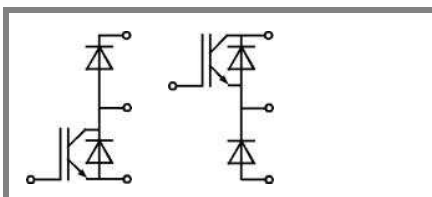
- One screw mounting module
- Trench4 IGBT technology
- CAL4 technology FWD

Typical Applications*

Remarks

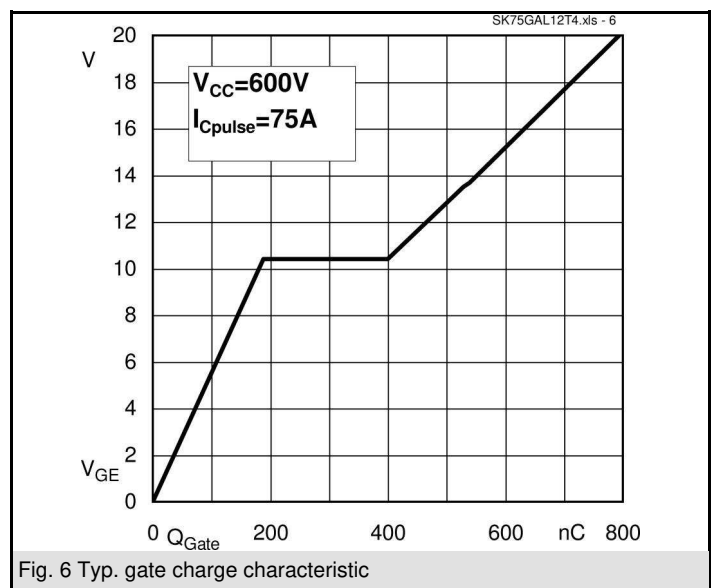
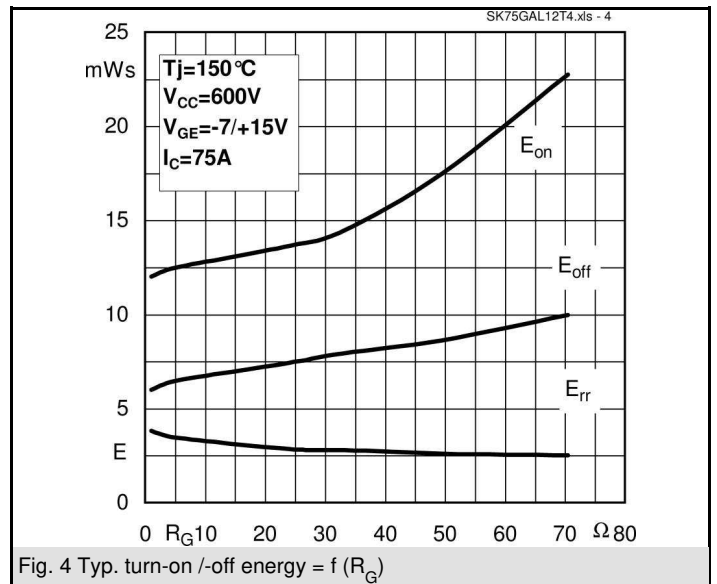
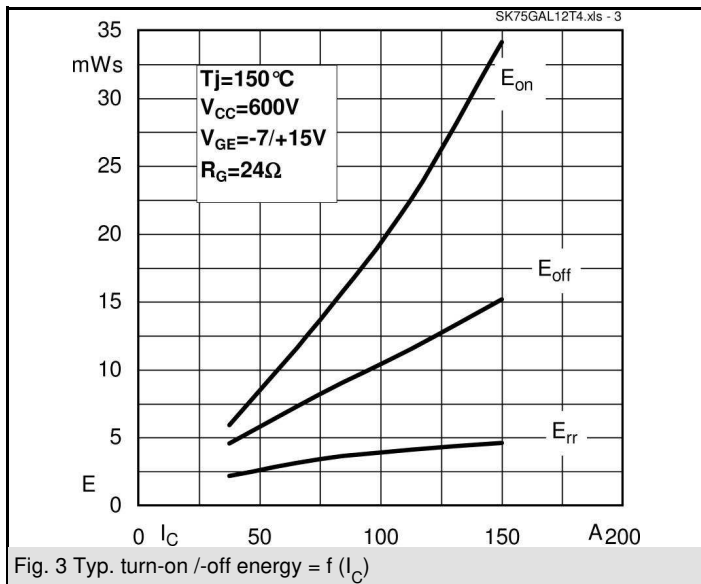
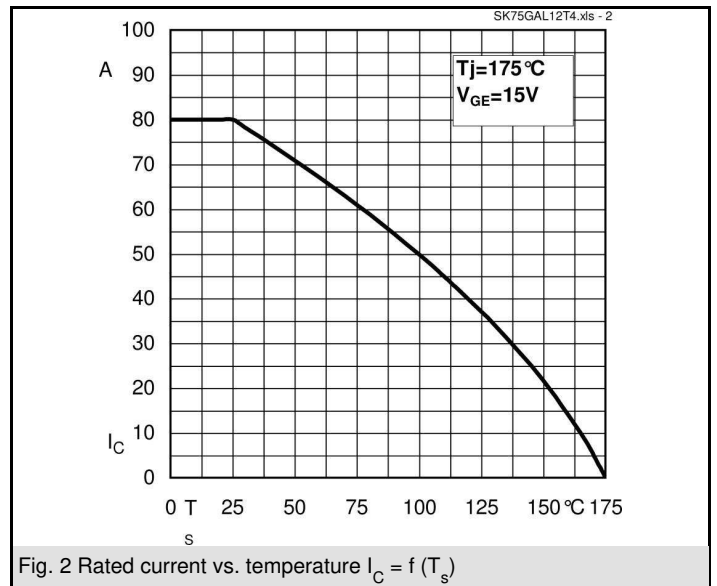
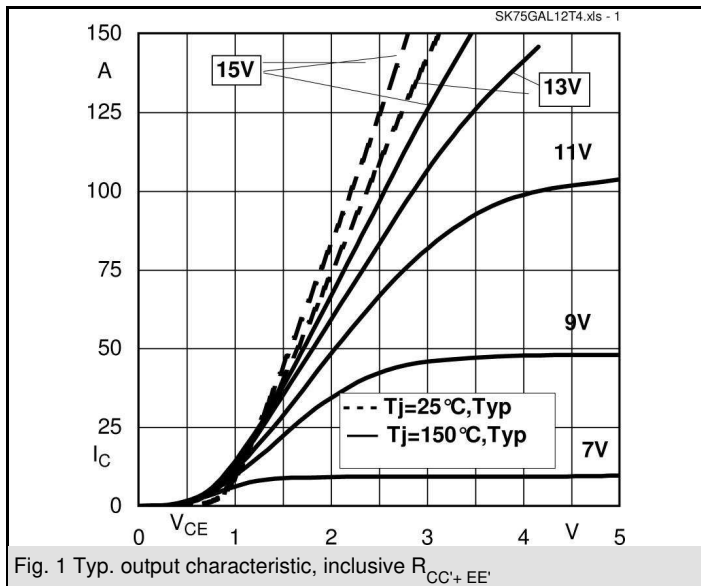
- $V_{CE,sat}$, V_F = chip level value

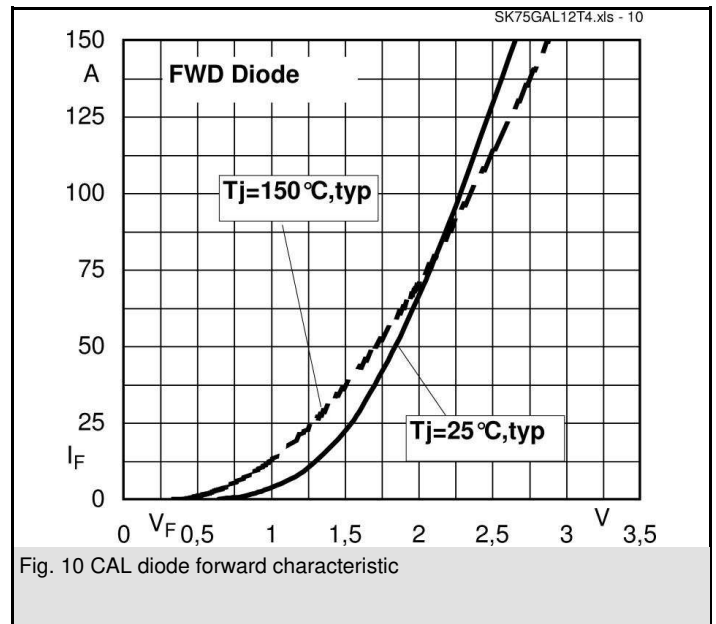
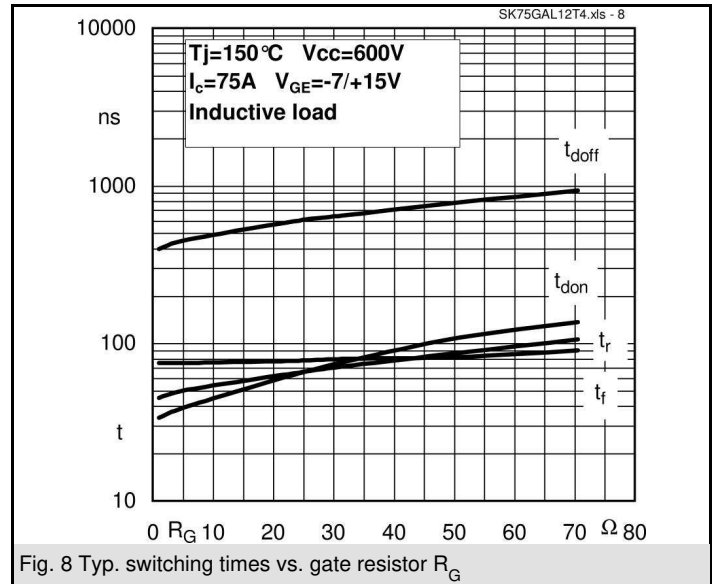
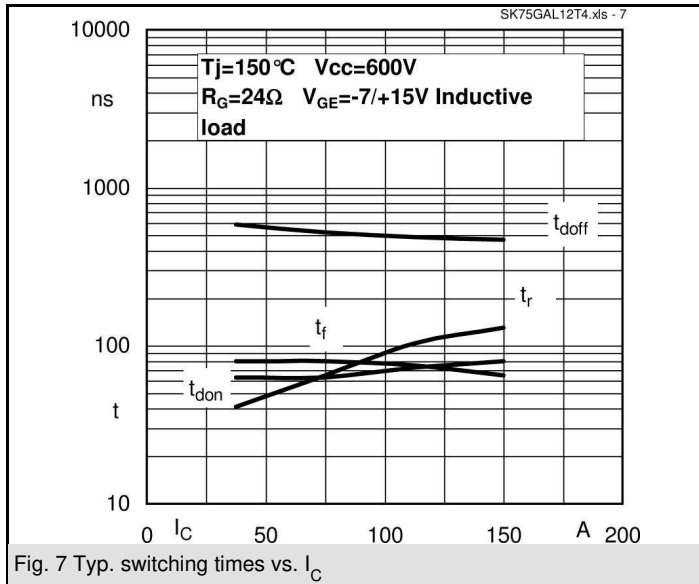
Characteristics		min.	typ.	max.	Units
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 15 \text{ A}; V_{GE} = 0 \text{ V}$		2,38	2,71	V
			2,44	2,77	V
			1,3	1,5	V
			0,9	1,1	V
V_{F0}					
			72	80,7	mΩ
			102,8	111,6	mΩ
r_F					
I_{RRM}	$I_F = \text{A}$				A
Q_{rr}					μC
E_{rr}	$V_{CC} = 600\text{V}$				mJ
$R_{th(j-s)D}$	per diode		2,34		K/W
Freewheeling Diode					
$V_F = V_{EC}$	$I_{Fnom} = 75 \text{ A}; V_{GE} = 0 \text{ V}$		2,1	2,5	V
			2,4	2,5	V
			1,3	1,5	V
			0,9	1,1	V
V_{F0}					
			12	13,3	V
			16	17,3	V
r_F					
I_{RRM}	$I_F = 75 \text{ A}$		45		A
Q_{rr}	$di/dt = 2000 \text{ A}/\mu\text{s}$		10		μC
E_{rr}	$V_{CC} = 600\text{V}$		3		mJ
$R_{th(j-s)FD}$	per diode		0,97		K/W
M_s	to heat sink			2,5	Nm
w			30		g
Temperature sensor					
R_{100}	$T_s = 100^\circ\text{C} (R_{25} = 5\text{k}\Omega)$		493±5%		Ω



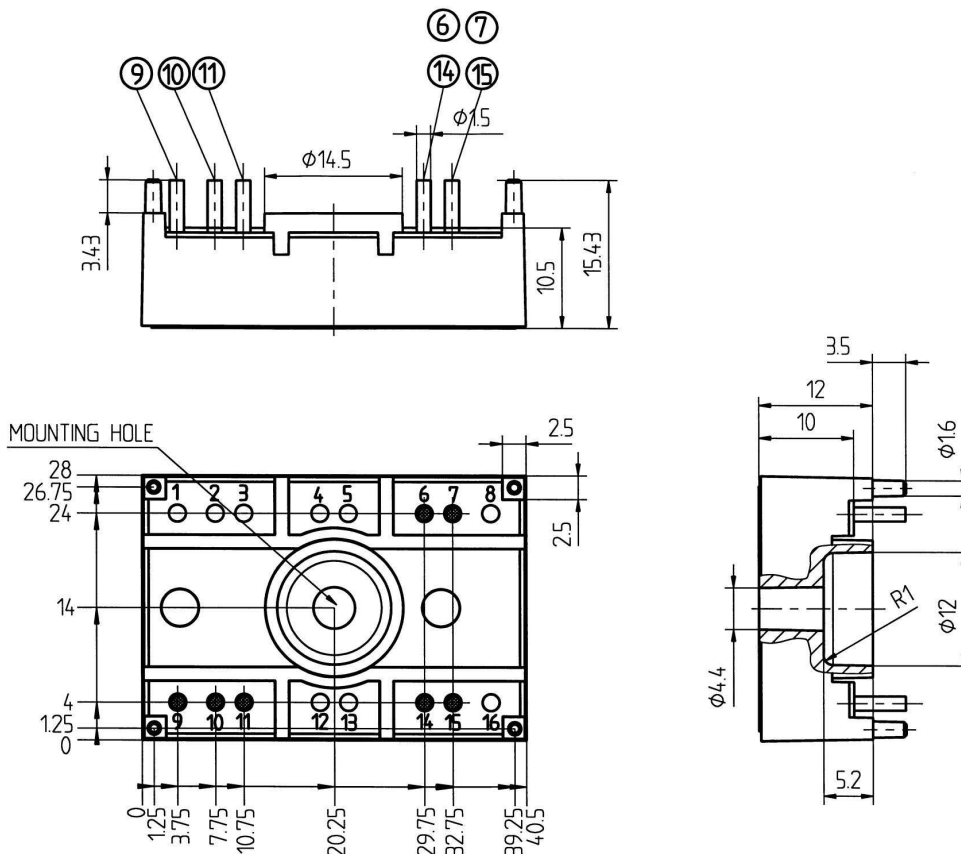
GAL

GAR

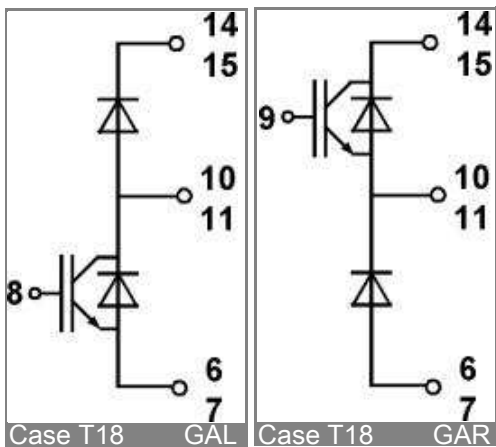




SK75GAL12T4



Case T18 (Suggested hole diameter for the solder pins and mounting plastic pins: 2mm)



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

*IMPORTANT INFORMATION AND WARNINGS

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